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GAP-151R-S8-SOLO

1U Rugged Edge Server- Rear I/O & Rear Power supply Single Socket 5th/4th Gen Intel[®] Xeon[®] Scalable Processors





GAP is a product family of Rugged aluminium Servers and Workstations designed for Edge applications that require a robust MIL-GRADE certified computing platform, suitable for operations in critical environments.

1U PLATFORM 510 MM

1 CPU 2TE

UP TO 9

3 I/O BOARDS

GAP-151R-S8-SOLO Rugged Edge Servers are powered by single-socket 5th Gen Intel® Xeon® / 4th Gen Intel® Xeon® Scalable Processors renowned for their robust architecture with enhanced Al acceleration and advanced security capabilities. Offering improved performance and efficiency, these servers are tailored to meet the demanding requirements of modern computing environments at the Edge.

The integrated IPMI services support monitoring, control, and management functions, sending alarm notifications in case of critical events.

GAP-151R-S8-SOLO are designed for 19" rackmounting and have a 1U chassis with a total overall depth of 540mm. Notably, the 19" front brackets of the chassis are strategically positioned in a backward orientation, reducing the required cabinet space to just 510mm once fully installed.

The rear I/O and rear power supply configuration offers versatile storage options, including an on board M.2 NVME SSD and either up to three removable 2.5" SAS SSD, six removable U.2 NVMe SSD or up to nine removable 2.5" SATA SSDs.

Moreover, this rugged server can accommodate up to two full-height full-lenght PCIe cards, in addition to one low-profile card.

For enhanced protection against shocks and vibrations, additional boards can be supplied with a dedicated retainer kit, ensuring optimal safety even during transport.

Built to meet MIL-STD-810F standards for temperature and shock resistance, as well as MIL-STD-167-1A standards for vibration tolerance, GAP Rugged Edge Servers ensure reliable operation under the challenging conditions often found at the Edge. Additionally, they can optionally be configured to comply with MIL-STD-461 standards for EMI/EMC, featuring MIL-grade connectors for either the power input or both the I/O connectors and power supply inputs.

All units are shipped with an inventory list to guarantee configuration control and reproducibility over time. Additionally, upon request, all server configurations can undergo specific thermal or mechanical environmental stress tests.



Technical Specifications



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System	5 th Gen Intel [®] Xeon [®] / 4 th Gen Intel [®] Xeon [®] Scalable processors, Single Socket LGA-	Mechanica Dimensions	al
	4677 (Socket E) supported, CPU TDP Up to 205W TDP	Material	
Memory	Up to 2TB ECC RDIMM, DDR5-4800MT/s in 8 DIMM slots	Colour	
Chipset	Intel® C741	Mounting	
Graphics	1 Aspeed AST2600 BMC port		
Network Connectivity	1x Dedicated IPMI LAN port 2x 10GbE with RJ45 connectors	Configuration	
Storage	On Board: 1x M.2 NVMe; M-Key, 2280/22110 2x SATA Disk on Module	Front Panel Leds / Buttons / Connectors	
	Removable:	Fans	
	Up to 3x 2.5" SAS SSD or Up to 6x U.2 NVMe SSD or Up to 9x 2.5" SATA SSD	Environme	nt
ТРМ	1x TPM Header	Operating	0
Motherboard I/O shield	1x VGA, 2x USB 3.0, 2x USB 2.0, 2x 10GbE, 1x IPMI, 1x COM (available on the rear panel)	Temperatures Storage	-:
Expansion slots	2x PCIe 5.0 x16 slot FHFL 1x PCIe 5.0 x16 slot low profile	Temperature	٨
Operative	Windows® 11 IoT Enterprise, Windows® 10 IoT Enterprise LTSC, Windows® Server	Humidity	5 N
Systems	2022, Windows® Server 2019, Linux	Operating	Λ
IPMI	IPMI2.0, SPM, Watchdog; SNMP and e-mail alarms and notifications	Vibrations Not Operating	1
Remote Monitoring	Monitoring, control and management functions (fan speed, temperature,	Vibrations	N
	functions (fan speed, temperature, voltage, redundant power failure, power consumption, disk health, RAID health, and	Operating Shocks	2 N
	memory health)		2
Power Supp	ly	EMC	L

Dimensions	540 mm full depth (W x H x D)	
Material	Aluminum with surface passivation treatment	
Colour	Black / RAL 9005 - Powder Coating	
Mounting	1U 19" rackmount chassis Optional Telescopic slides	
Configuration	Rear I/O - Rear Power Supply	
Front Panel Leds / Buttons / Connectors	Power On/Off button with LED Reset button with LED 2x USB 3.0	
Fans	6x internal PWM fans	
Environment Operating Temperatures	ental - (Design to meet) 0°C to +50°C MIL-STD-810H, Method 501.7 & 502.7 -20°C to +60°C (depending on configuration)	
Storage Temperature	-40°C to +70°C MIL-STD-810H, Method 501.7 & 502.7	
Humidity	5% – 95% non-condensing MIL-STD-810H 507.6	
Operating Vibrations	MIL-STD-167-1A, Type I	
Not Operating Vibrations	1.17 Grms, 5-500 Hz MIL-STD-810H, Method 514.8	
Operating Shocks	20g / 11ms – half sine MIL-STD-810G, Method 516.7	
	Directive 2014/35/UE-LVD Directive 2014/30/UE-EMC Directive 2011/65/	

UE - RoHS

461G (on request)

Regulation EC No 1907/2006 | MIL-STD-

483 x 44 x 510 mm

Power Supply

AC or DC Redundant Power Supply -**Power Supply** Optional AC Single

GAP servers and workstations are designed in accordance with the environmental specifications indicated. Some parameters depend on the configuration. Equipment may be subjected to dedicated test profiles.